

20180111006		<b>PCN Date:</b>	January 12, 2018
<b>Title:</b>	Datasheet for SN74LVC1G06		
<b>Customer Contact:</b>	PCN Manager	<b>Dept:</b>	Quality Services
<b>Change Type:</b>			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Data Sheet
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process

### Notification Details

#### Description of Change:

Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.



**SN74LVC1G06**

SCES295Z – JUNE 2000 – REVISED NOVEMBER 2017

Changes from Revision Y (February 2017) to Revision Z	Page
• Changed values in the Thermal Information table to align with JEDEC standards .....	5
• Updated Feature Description to include more detailed information about specific device features. ....	9
• Added DPW layout example .....	13

The datasheet number will be changing.

Device Family	Change From:	Change To:
SN74LVC1G06	SCES295Y	SCES295Z

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/SN74LVC1G06>

#### Reason for Change:

To accurately reflect device usage in specific application use cases.

#### Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a recommendation change to application circuit only. There are no changes to the actual device.

#### Changes to product identification resulting from this PCN:

None.

#### Product Affected:

SN74LVC1G06DBVR	SN74LVC1G06DCKR	SN74LVC1G06DCKTG4	SN74LVC1G06DSFR
SN74LVC1G06DBVRE4	SN74LVC1G06DCKRE4	SN74LVC1G06DRLR	SN74LVC1G06YZPR
SN74LVC1G06DBVRG4	SN74LVC1G06DCKRG4	SN74LVC1G06DRY2	SN74LVC1G06YZVR
SN74LVC1G06DBVT	SN74LVC1G06DCKT	SN74LVC1G06DRYR	
SN74LVC1G06DBVTG4	SN74LVC1G06DCKTE4	SN74LVC1G06DSF2	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	<a href="mailto:PCNAmericasContact@list.ti.com">PCNAmericasContact@list.ti.com</a>
Europe	<a href="mailto:PCNEuropeContact@list.ti.com">PCNEuropeContact@list.ti.com</a>
Asia Pacific	<a href="mailto:PCNAsiaContact@list.ti.com">PCNAsiaContact@list.ti.com</a>
Japan	<a href="mailto:PCNJapanContact@list.ti.com">PCNJapanContact@list.ti.com</a>